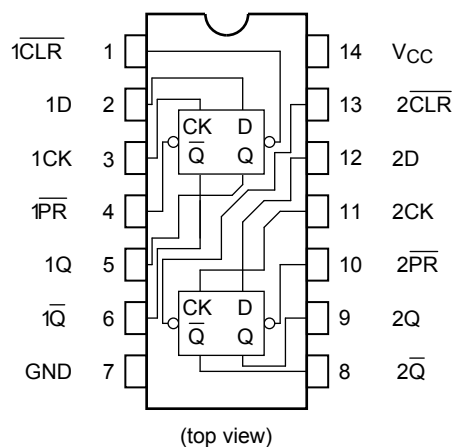
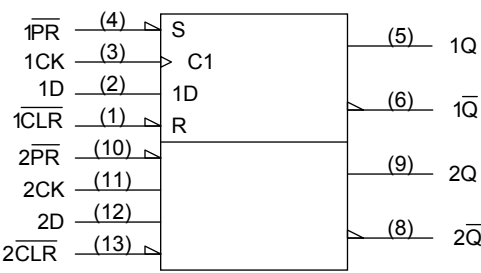


Pin Assignment



IEC Logic Symbol

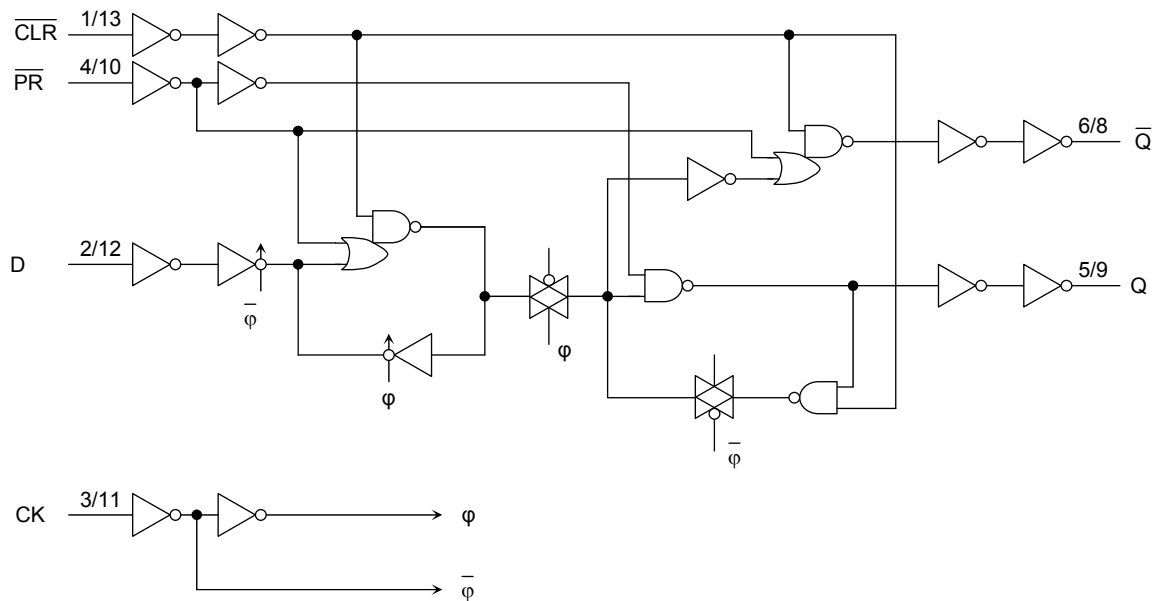


Truth Table

| Inputs |    |   |    | Outputs        |                 | Function  |
|--------|----|---|----|----------------|-----------------|-----------|
| CLR    | PR | D | CK | Q              | Q̄              |           |
| L      | H  | X | X  | L              | H               | Clear     |
| H      | L  | X | X  | H              | L               | Preset    |
| L      | L  | X | X  | H              | H               | —         |
| H      | H  | L | ↑  | L              | H               | —         |
| H      | H  | H | ↑  | H              | L               | —         |
| H      | H  | X | ↓  | Q <sub>n</sub> | Q̄ <sub>n</sub> | No Change |

X: Don't care

System Diagram



**Absolute Maximum Ratings (Note 1)**

| Characteristics             | Symbol    | Rating                             | Unit |
|-----------------------------|-----------|------------------------------------|------|
| Supply voltage range        | $V_{CC}$  | -0.5 to 7.0                        | V    |
| DC input voltage            | $V_{IN}$  | -0.5 to $V_{CC} + 0.5$             | V    |
| DC output voltage           | $V_{OUT}$ | -0.5 to $V_{CC} + 0.5$             | V    |
| Input diode current         | $I_{IK}$  | $\pm 20$                           | mA   |
| Output diode current        | $I_{OK}$  | $\pm 50$                           | mA   |
| DC output current           | $I_{OUT}$ | $\pm 50$                           | mA   |
| DC $V_{CC}$ /ground current | $I_{CC}$  | $\pm 100$                          | mA   |
| Power dissipation           | $P_D$     | 500 (DIP) (Note 2)/180 (SOP/TSSOP) | mW   |
| Storage temperature         | $T_{stg}$ | -65 to 150                         | °C   |

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 2: 500 mW in the range of  $T_a = -40^{\circ}\text{C}$  to  $65^{\circ}\text{C}$ . From  $T_a = 65^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ , a derating factor of  $-10\text{ mW}/^{\circ}\text{C}$  should be applied up to 300 mW.

**Operating Ranges (Note)**

| Characteristics          | Symbol    | Rating  | Unit |
|--------------------------|-----------|---|------|
| Supply voltage           | $V_{CC}$  | 2.0 to 5.5  | V    |
| Input voltage            | $V_{IN}$  | 0 to $V_{CC}$   | V    |
| Output voltage           | $V_{OUT}$ | 0 to $V_{CC}$   | V    |
| Operating temperature    | $T_{opr}$ | -40 to 85   | °C   |
| Input rise and fall time | $dt/dV$   | 0 to 100 ( $V_{CC} = 3.3 \pm 0.3\text{ V}$ )<br>0 to 20 ( $V_{CC} = 5 \pm 0.5\text{ V}$ ) | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

## DC Characteristics

| Characteristics           | Symbol          | Test Condition                                       |                                 | Ta = 25°C           |                      |                   | Ta = -40 to 85°C     |                      | Unit |
|---------------------------|-----------------|--|---------------------------------|---------------------|----------------------|-------------------|----------------------|----------------------|------|
|                           |                 |  |                                 | V <sub>CC</sub> (V) | Min                  | Typ.              | Max                  | Min                  | Max  |
| High-level input voltage  | V <sub>IH</sub> | —  |                                 | 2.0<br>3.0<br>5.5   | 1.50<br>2.10<br>3.85 | —<br>—<br>—       | —<br>—<br>—          | 1.50<br>2.10<br>3.85 | V    |
| Low-level input voltage   | V <sub>IL</sub> | —  |                                 | 2.0<br>3.0<br>5.5   | —<br>—<br>—          | —<br>—<br>—       | 0.50<br>0.90<br>1.65 | —<br>0.90<br>1.65    | V    |
| High-level output voltage | V <sub>OH</sub> | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = -50 µA        | 2.0<br>3.0<br>4.5   | 1.9<br>2.9<br>4.4    | 2.0<br>3.0<br>4.5 | —<br>—<br>—          | 1.9<br>2.9<br>4.4    | V    |
|                           |                 |  | I <sub>OH</sub> = -4 mA         | 3.0                 | 2.58                 | —                 | —                    | 2.48                 |      |
|                           |                 |  | I <sub>OH</sub> = -24 mA        | 4.5                 | 3.94                 | —                 | —                    | 3.80                 |      |
|                           |                 |  | I <sub>OH</sub> = -75 mA (Note) | 5.5                 | —                    | —                 | —                    | 3.85                 |      |
| Low-level output voltage  | V <sub>OL</sub> | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OL</sub> = 50 µA         | 2.0<br>3.0<br>4.5   | —<br>—<br>—          | 0.0<br>0.0<br>0.0 | 0.1<br>0.1<br>0.1    | —<br>—<br>—          | V    |
|                           |                 |  | I <sub>OL</sub> = 12 mA         | 3.0                 | —                    | —                 | 0.36                 | —                    |      |
|                           |                 |  | I <sub>OL</sub> = 24 mA         | 4.5                 | —                    | —                 | 0.36                 | —                    |      |
|                           |                 |  | I <sub>OL</sub> = 75 mA (Note)  | 5.5                 | —                    | —                 | —                    | —                    |      |
| Input leakage current     | I <sub>IN</sub> | V <sub>IN</sub> = V <sub>CC</sub> or GND             |                                 | 5.5                 | —                    | —                 | ±0.1                 | —                    | µA   |
| Quiescent supply current  | I <sub>CC</sub> | V <sub>IN</sub> = V <sub>CC</sub> or GND             |                                 | 5.5                 | —                    | —                 | 4.0                  | —                    | µA   |

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

Timing Requirements (input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

| Characteristics   | Symbol             | Test Condition |  | Ta = 25°C           | Ta = -40 to 85°C | Unit |
|---|--------------------|----------------|--|---------------------|------------------|------|
|   |                    |                |  | V <sub>CC</sub> (V) | Limit            |      |
| Minimum pulse width (CK)  | t <sub>w</sub> (L) | —              |  | 3.3 ± 0.3           | 7.0              | ns   |
|   | t <sub>w</sub> (H) |                |  | 5.0 ± 0.5           | 5.0              |      |
| Minimum pulse width ( $\overline{\text{CLR}}$ , $\overline{\text{PR}}$ )  | t <sub>w</sub> (L) | —              |  | 3.3 ± 0.3           | 7.0              | ns   |
|   |                    |                |  | 5.0 ± 0.5           | 5.0              |      |
| Minimum set-up time   | t <sub>s</sub>     | —              |  | 3.3 ± 0.3           | 6.0              | ns   |
|   |                    |                |  | 5.0 ± 0.5           | 3.5              |      |
| Minimum hold time   | t <sub>h</sub>     | —              |  | 3.3 ± 0.3           | 1.0              | ns   |
|   |                    |                |  | 5.0 ± 0.5           | 1.0              |      |
| Minimum removal time ( $\overline{\text{CLR}}$ , $\overline{\text{PR}}$ ) | t <sub>rem</sub>   | —              |  | 3.3 ± 0.3           | 4.0              | ns   |
|   |                    |                |  | 5.0 ± 0.5           | 2.0              |      |

**AC Characteristics ( $C_L = 50 \text{ pF}$ ,  $R_L = 500 \Omega$ , input:  $t_r = t_f = 3 \text{ ns}$ )**

| Characteristics   | Symbol                               | Test Condition |                        | Ta = 25°C |            |             | Ta =<br>-40 to 85°C |              | Unit |
|---|--------------------------------------|----------------|------------------------|-----------|------------|-------------|---------------------|--------------|------|
|   |                                      |                | V <sub>CC</sub> (V)    | Min       | Typ.       | Max         | Min                 | Max          |      |
| Propagation delay time<br>(CK-Q, $\overline{Q}$ )   | t <sub>pLH</sub><br>t <sub>pHL</sub> | —              | 3.3 ± 0.3<br>5.0 ± 0.5 | —<br>—    | 8.2<br>6.1 | 13.9<br>8.7 | 1.0<br>1.0          | 16.0<br>10.0 | ns   |
| Propagation delay time<br>( $\overline{\text{CLR}}$ , $\overline{\text{PR}}$ -Q, $\overline{Q}$ ) | t <sub>pLH</sub><br>t <sub>pHL</sub> | —              | 3.3 ± 0.3<br>5.0 ± 0.5 | —<br>—    | 8.0<br>5.7 | 13.1<br>8.2 | 1.0<br>1.0          | 15.0<br>9.4  | ns   |
| Maximum clock frequency   | f <sub>max</sub>                     | —              | 3.3 ± 0.3<br>5.0 ± 0.5 | 60<br>100 | 120<br>160 | —<br>—      | 60<br>100           | —<br>—       | MHz  |
| Input capacitance   | C <sub>IN</sub>                      | —              |                        | —         | 5          | 10          | —                   | 10           | pF   |
| Power dissipation capacitance   | C <sub>PD</sub>                      | (Note)         |                        | —         | 77         | —           | —                   | —            | pF   |

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC(\text{opr})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per F/F)}$$

## Package Dimensions

DIP14-P-300-2.54

Unit : mm

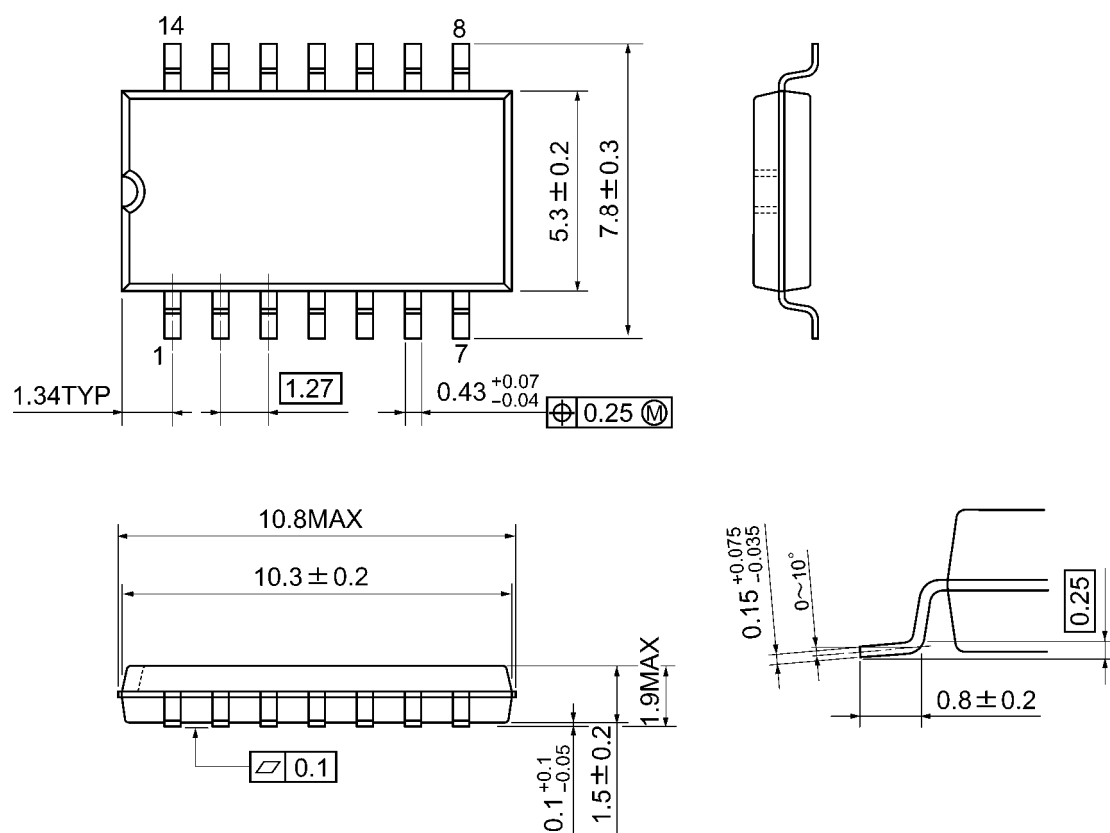


Weight: 0.96 g (typ.)

## Package Dimensions

SOP14-P-300-1.27A

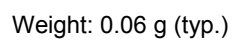
Unit: mm



Weight: 0.18 g (typ.)

## TSSOP14-P-0044-0.65A

Unit: mm



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